

MOSFET

OptiMOS™ 5 Power-Transistor, 60 V

Features

- N-channel, normal level
- Very low on-resistance R_{DS(on)}
- Superior thermal resistance
- Optimized design for double side cooling
- 100% avalanche tested
- Pb-free lead plating; RoHS compliant
- Halogen-free according to IEC61249-2-21

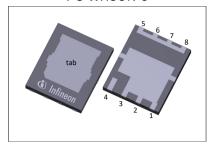
Product validation

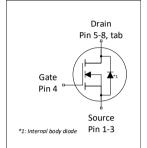
Fully qualified according to JEDEC for Industrial Applications

Table 1 Key Performance Parameters

Parameter	Value	Unit						
V_{DS}	60	V						
R _{DS(on),max}	0.9	mΩ						
I_{D}	445	A						
$Q_{\rm oss}$	127	nC						
Q_{G}	120	nC						

PG-WHSON-8







Type/Ordering Code	Package	Marking	Related Links
IQD009N06NM5SC	PG-WHSON-8	FA	-

Public

OptiMOS™ 5 Power-Transistor, 60 V IQD009N06NM5SC



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OptiMOS™ 5 Power-Transistor, 60 V IQD009N06NM5SC



1 Maximum ratings

at T_A =25 °C, unless otherwise specified

Table 2 Maximum ratings

Parameter	Symbol	Values			Unit	Note / Test Condition	
raiailletei	Syllibot	Min.	Тур.	Max.	Ollic	Note/ Test Condition	
Continuous drain current ¹⁾	I_{D}	-	-	445 315 265 42	А	$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =6 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =10 V, $T_{\rm A}$ =25 °C, $R_{\rm thJA}$ =50 °C/W ²⁾	
Pulsed drain current ³⁾	I _{D,pulse}	-	-	1780	А	<i>T</i> _C =25 °C	
Avalanche energy, single pulse ⁴⁾	E _{AS}	-	-	1115	mJ	$I_{\rm D}$ =50 A, $R_{\rm GS}$ =25 Ω	
Gate source voltage	V_{GS}	-20	-	20	V	-	
Power dissipation	P_{tot}	-	-	333 3.0	W	$T_{\rm C}$ =25 °C $T_{\rm A}$ =25 °C, $R_{\rm thJA}$ =50 °C/W ²⁾	
Operating and storage temperature	$T_{\rm j}$, $T_{\rm stg}$	-55	-	175	°C	-	

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions.

2 Thermal characteristics

Table 3 Thermal characteristics

Parameter	Symbol	Values			Unit	Note/ Test Condition
raiametei	Syllibot	Min.	Тур.	Мах.	Offic	Note/ Test Condition
Thermal resistance, junction - case, bottom	R_{thJC}	-	-	0.45	°C/W	-
Thermal resistance, junction - case, top	R_{thJC}	-	-	0.56	°C/W	-
Thermal resistance, junction - ambient, 6 cm ² cooling area ⁵⁾	$R_{ m thJA}$	-	-	50	°C/W	-

Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm 2 (one layer, 70 μ m thick) copper area for source connection. PCB is vertical in still air.

Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm 2 (one layer, 70 μ m thick) copper area for source connection. PCB is vertical in still air.

³⁾ See Diagram 3 for more detailed information

⁴⁾ See Diagram 13 for more detailed information

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3 Electrical characteristics

at T_i =25 °C, unless otherwise specified

Table 4 Static characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition	
raiailletei	Syllibol	Min.	Тур.	Мах.	Ollic	Note/ Test Condition	
Drain-source breakdown voltage	$V_{(BR)DSS}$	60	-	-	V	$V_{\rm GS}$ =0 V, $I_{\rm D}$ =1 mA	
Gate threshold voltage	$V_{\rm GS(th)}$	2.1	2.8	3.3	V	$V_{\rm DS} = V_{\rm GS}, I_{\rm D} = 163 \mu \text{A}$	
Zero gate voltage drain current	I _{DSS}	-	0.1 10	1 100	μΑ	$V_{\rm DS}$ =60 V, $V_{\rm GS}$ =0 V, $T_{\rm j}$ =25 °C $V_{\rm DS}$ =60 V, $V_{\rm GS}$ =0 V, $T_{\rm j}$ =125 °C	
Gate-source leakage current	I_{GSS}	-	10	100	nA	V _{GS} =20 V, V _{DS} =0 V	
Drain-source on-state resistance	$R_{\mathrm{DS(on)}}$	-	0.8 1.1	0.9 1.27	mΩ	$V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A $V_{\rm GS}$ =6 V, $I_{\rm D}$ =50 A	
Gate resistance ⁶⁾	R_{G}	-	0.58	-	Ω	-	
Transconductance	g_{fs}	-	190	-	S	$ V_{\rm DS} \ge 2 I_{\rm D} R_{\rm DS(on)max}, I_{\rm D} = 50 \text{ A}$	

⁶⁾ Defined by design. Not subject to production test.

Table 5 Dynamic characteristics

Darameter	Symbol		Values			Note / Test Condition	
Parameter	Min. Typ. Max.		Unit	Note/ Test Condition			
Input capacitance ⁷⁾	C _{iss}	-	9000	12000	pF	$V_{\rm GS}$ =0 V, $V_{\rm DS}$ =30 V, f =1 MHz	
Output capacitance 7)	$C_{\rm oss}$	-	1800	2300	pF	$V_{\rm GS}$ =0 V, $V_{\rm DS}$ =30 V, f =1 MHz	
Reverse transfer capacitance ⁷⁾	C _{rss}	-	110	190	pF	$V_{\rm GS}$ =0 V, $V_{\rm DS}$ =30 V, f =1 MHz	
Turn-on delay time	$t_{d(on)}$	-	17	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1. 6 Ω	
Rise time	t _r	-	9	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1. 6 Ω	
Turn-off delay time	$t_{\sf d(off)}$	-	34	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.	
Fall time	t_{f}	-	12	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.	

 $^{^{7)}}$ Defined by design. Not subject to production test.

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Table 6 Gate charge characteristics 8)

Parameter	Symbol	Values			Unit	Nata/Task Canditian	
raiailletei	Symbol	Min.	Тур.	Мах.	Oilit	Note/ Test Condition	
Gate to source charge	$Q_{\rm gs}$	-	38	-	nC	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V	
Gate charge at threshold	$Q_{\mathrm{g(th)}}$	-	25	-	nC	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V	
Gate to drain charge ⁹⁾	$Q_{ m gd}$	-	20	30	nC	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V	
Switching charge	Q_{sw}	-	33	-	nC	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V	
Gate charge total ⁹⁾	$Q_{ m g}$	-	120	150	nC	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V	
Gate plateau voltage	$V_{ m plateau}$	-	4.2	-	V	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V	
Gate charge total, sync. FET	$Q_{g(sync)}$	-	107	-	nC	$V_{\rm DS}$ =0.1 V, $V_{\rm GS}$ =0 to 10 V	
Output charge ⁹⁾	Q _{oss}	-	127	169	nC	V _{DS} =30 V, V _{GS} =0 V	

 $^{^{8)}~~{\}rm See}$ "Gate charge waveforms" for parameter definition

Table 7 Reverse diode

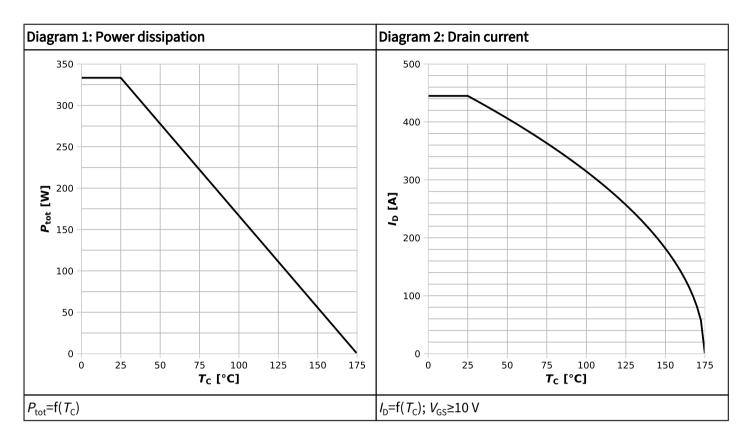
Parameter	Symbol	Values			Unit	Note/ Test Condition	
raiailletei	Syllibol	Min.	Тур.	Max.	Oilit	Note/ Test Condition	
Diode continuous forward current	Is	-	-	252	А	<i>T</i> _C =25 °C	
Diode pulse current	I _{S,pulse}	-	-	1780	А	<i>T</i> _C =25 °C	
Diode forward voltage	$V_{\rm SD}$	-	0.81	1.0	V	$V_{\rm GS}$ =0 V, $I_{\rm F}$ =50 A, $T_{\rm j}$ =25 °C	
Reverse recovery time ¹⁰⁾	t _{rr}	-	45	90	ns	$V_{\rm R}$ =30 V, $I_{\rm F}$ =25 A, d $i_{\rm F}$ /d t =100 A/ μ s	
Reverse recovery charge ¹⁰⁾	$Q_{\rm rr}$	-	51	102	nC	V_R =30 V, I_F =25 A, d i_F /d t =100 A/ μ s	
Reverse recovery time ¹⁰⁾	t _{rr}	-	28	56	ns	$V_{\rm R}$ =30 V, $I_{\rm F}$ =50 A, d $i_{\rm F}$ /d t =1000 A/ μ s	
Reverse recovery charge ¹⁰⁾	$Q_{\rm rr}$	-	266	532	nC	V_R =30 V, I_F =50 A, d I_F /d t =1000 A/ μ s	

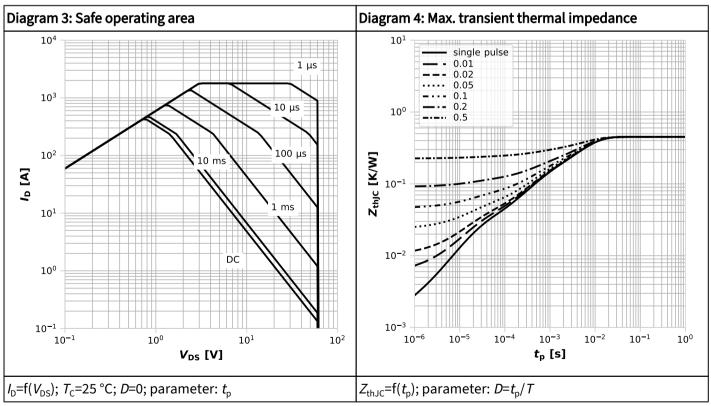
 $^{^{10)}}$ Defined by design. Not subject to production test.

⁹⁾ Defined by design. Not subject to production test.

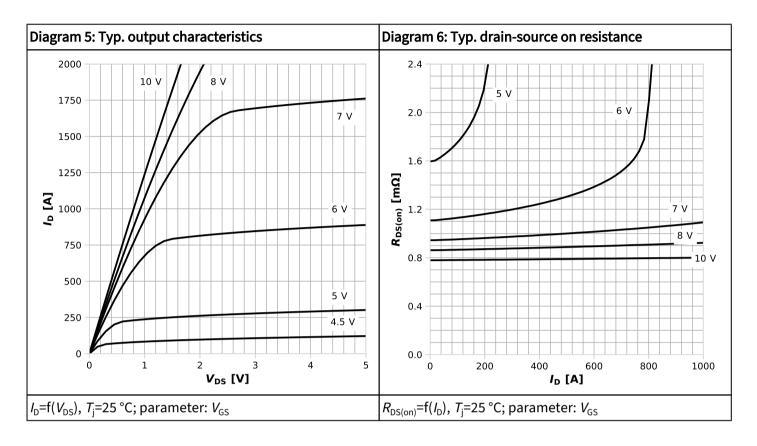


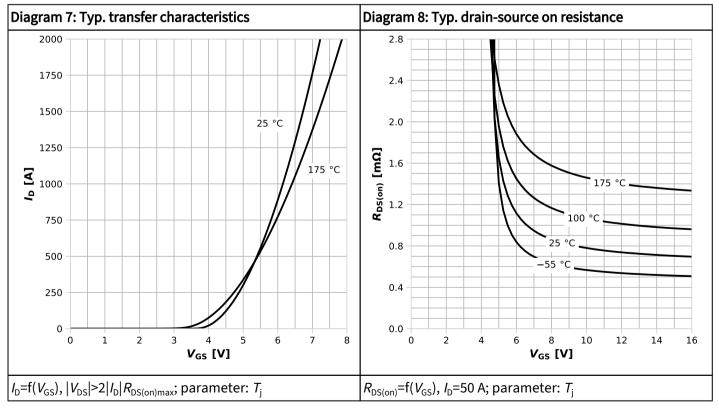
4 Electrical characteristics diagrams



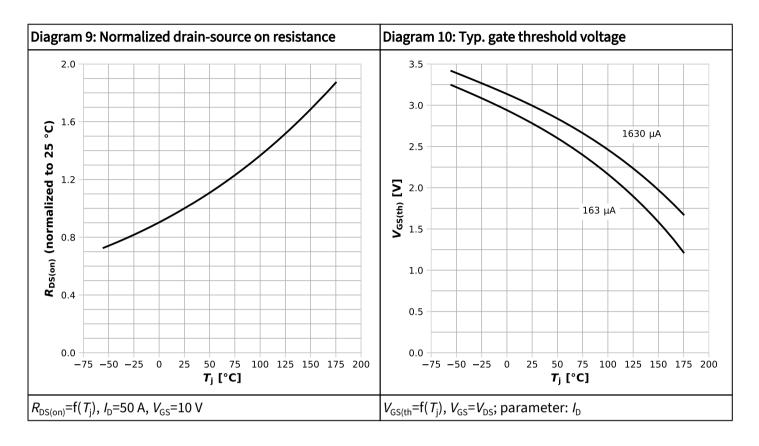


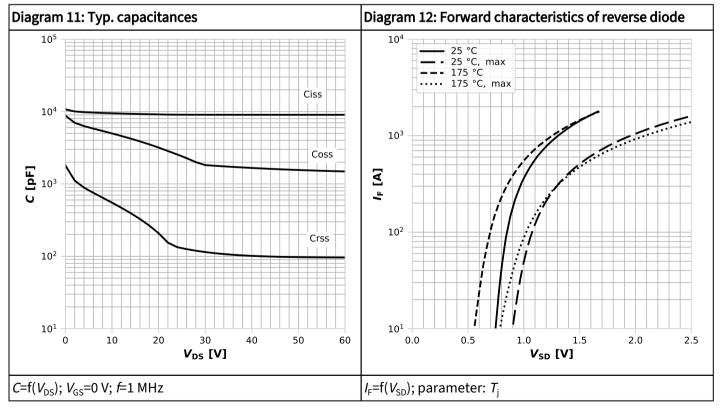




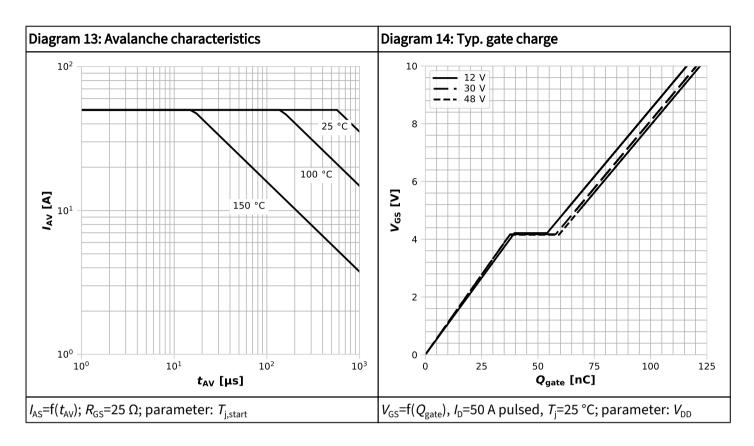


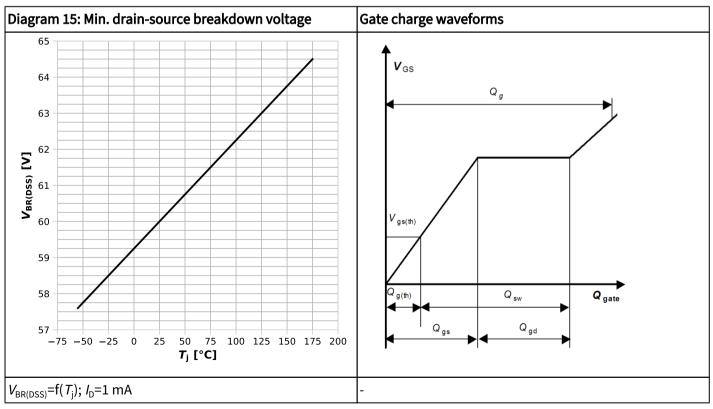






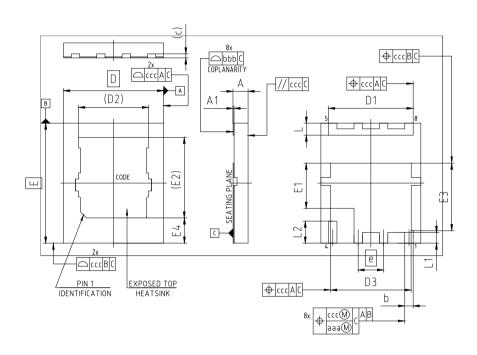








5 Package Outlines



PACKAGE - GROUP NUMBER:	PG-WHS	ON-8-U02				
DIMENSIONS MILLIMETERS		DIMENSIONS	MILLIN	METERS		
DIMENSIONS	MIN.	MAX.	DIMENSIONS	MIN.	MAX.	
Α	0.55	0.75	е	1.	.27	
A1	0.00	0.05	L	0.50	0.70	
b	0.32	0.52	L1	0.44	0.64	
С	0.	20	L2	1.00	1.20	
D	5.00		aaa	0.05		
D1	4.13	4.33	bbb	0.08		
D2	3.	50	ccc	0.10		
D3	3.93	4.13				
E	6.	00	1			
E1	2.16	2.36	1			
E2	4.	03	1			
E3	3.28	3.48	1			
E4	1.16	1.36	1			

NOTE: DIMENSIONS DO NOT INCLUDE MOLD FLASH, PROTRUSION OR GATE BURRS

Figure 1 Outline PG-WHSON-8, dimensions in mm



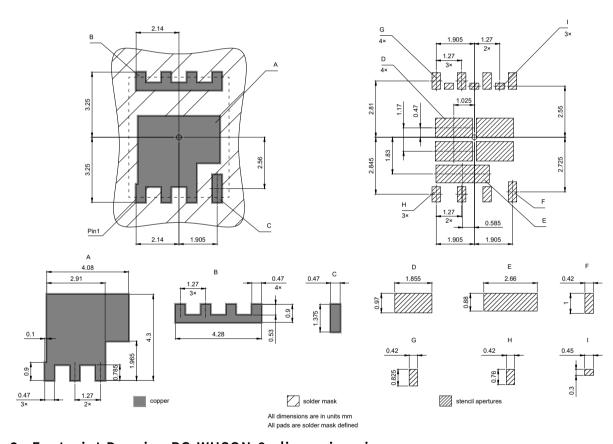


Figure 2 Footprint Drawing PG-WHSON-8, dimensions in mm

OptiMOS™ 5 Power-Transistor, 60 V IQD009N06NM5SC



Revision History

IQD009N06NM5SC

Revision 2024-10-02, Rev. 2.1

Previous Revision

Revision	Date	Subjects (major changes since last revision)
2.0	2024-06-14	Release of final
2.1	2024-10-02	Update package drawing and diagram circuit

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